

All Mini-Circuits products are manufactured under exacting quality assurance and control standards, and are capable of meeting published specifications after being subjected to any or all of the following physical and environmental test.

Specification	Test/Inspection Condition	Reference/Spec
Operating Temperature	-54° to 85°C Ambient Environment	Individual Model Data Sheet
Storage Temperature	-55° to 100° C Ambient Environment	Individual Model Data Sheet
Thermal Shock	-55° to 100°C, 10 cycles	MIL-STD-202, Method 107, Condition A, except +100°C & 10 cycles
Constant Acceleration	5000g, Y1 axis	MIL-STD-883, Method 2001, Condition A, except Y1 axis only
Solderability	10X Magnification	J-STD-002, 95% Coverage
Resistance to Solder Heat	260°C for 10 seconds	MIL-STD-202, Method 210, Condition B
Marking Resistance to Solvents	Isopropyl alcohol + mineral spirits at 25°C; terpene defluxer at 25°C; distilled water + proylene glycol monomethyl ether + monoethanolamine at 63°C to 70°C	MIL-STD-202, Method 215
Gross Leak	125°C Bubble Test	MIL-STD-202, Method 112, Condition D